THE COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: YING-HO CHEN, JIH-CHURNG TWU AND WENG CHANG

For: MULTILAYER INTERFACE IN COPPER CMP FOR LOW K DIELECTRIC



01/16/01

closed are:

4 sheets of drawing(s) - formal.

An assignment of the invention to Taiwan Semiconductor Manufacturing Company

An associate power of attorney

Applicant claims small entity status

Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	SMALL ENTITY		
FOR:	NO. FILED	NO. EXTRA	RATE	FEE	
BASIC FEE				\$ 710 .	
TOTAL CLAIMS	57 -20=	37	x 18 =	\$ 666.	
INDEP CLAIMS	3 -3=	0	x 80 =	\$ 0.	
MULTIPLE					
		ST	JB TOTAL	\$ 1,376.	
	SSIGNMENT	\$40.			
		TO	OTAL	\$ 1,416.	

Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,416. A duplicate copy of this sheet is enclosed.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.

 $oldsymbol{x}$ Any additional filing fees required under 37 CFR §1.16.

X Any patent application processing fees under 37 CFR §1.17.

Respectfully subhitted,

STEPHEN B. ACKERMAN, REG. NO. 37,761

REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

First Named Inventor		7	100	λ,	- hte	2	Chen
Title	Mutila	yer	· I	<u></u>	er-f	Ò	ce In
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I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

Jan. 9, 2001

Signature

Typed or printed name

437,76

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).